ON Semiconductor

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NDS9948

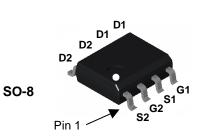
Dual 60V P-Channel PowerTrench[®] MOSFET

General Description

This P-Channel MOSFET is a rugged gate version of ON Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (4.5V - 20V).

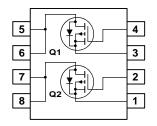
Applications

- Power management
- Load switch
- Battery protection



Features

- Low gate charge (9nC typical)
- Fast switching speed
- High performance trench technology for extremely
 low R_{DS(ON)}
- High power and current handling capability



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DSS}	Drain-Sourc	e Voltage		-60	V
V _{GSS}	Gate-Sourc	e Voltage		±20	V
I _D	Drain Curre	nt – Continuous	(Note 1a)	-2.3	А
		– Pulsed		-10	
P _D	Power Dissipation for Dual Operation			2	W
	Power Diss	pation for Single Operation	ON (Note 1a)	1.6	
			(Note 1b)	1.0	
			(Note 1c)	0.9	
T _J , T _{STG}	Operating a	nd Storage Junction Tem	-55 to +175	°C	
Therma	I Charac	teristics			
$R_{\theta JA}$	Thermal Re	sistance, Junction-to-Aml	bient (Note 1a)	78	°C/W
			(Note 1c)	135	°C/W
R _{θJC}	Thermal Resistance, Junction-to-Case		Se (Note 1)	40	°C/W
Packag	e Markin	g and Ordering	Information		
•	Marking	Device	Reel Size	Tape width	Quantity
NDS9948		NDS9948	13"	12mm	2500 units

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Publication Order Number: NDS9948/D

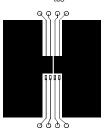
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	Durce Avalanche Ratings (Not	e 2)	l	I		l
W _{DSS}	Drain-Source Avalanche Energy	Single Pulse, V _{DD} =–54 V			15	mJ
I _{AR}	Drain-Source Avalanche Current				-10	Α
Off Char	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = -250 \mu A$	-60			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25° C		-52		mV/°0
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -40 V$, $V_{GS} = 0 V$ $V_{DS} = -40 V$, $V_{GS} = 0 V T_J = -55^{\circ}C$			-2 -25	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 20 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
	Gate-Body Leakage, Reverse	$V_{GS} = -20 \text{ V} \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-1	-1.5	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu$ A, Referenced to 25° C		4		mV/°0
R _{DS(on)}	Static Drain–Source	$V_{GS} = -10 \text{ V}, \qquad I_D = -2.3 \text{ A}$		138	250	mΩ
	On-Resistance	$V_{GS} = -4.5 \text{ V}, I_D = -1.6 \text{ A}$		175	500	
1	On–State Drain Current	$V_{GS} = -10 \text{ V}, I_D = -2.3\text{A}, \text{ T}_J = 125^{\circ}\text{C}$ $V_{GS} = -10 \text{ V}, V_{DS} = -5 \text{ V}$	10	225	433	٨
I _{D(on)}	Forward Transconductance	$V_{GS} = -10 \text{ V}, V_{DS} = -3 \text{ V}$ $V_{DS} = -10 \text{ V}, I_D = -2.3 \text{ A}$	-10	5		A S
g _{FS}		$v_{\rm DS} = -10 v$; $i_{\rm D} = -2.3 A$		5		5
	c Characteristics		1	004		
Ciss	Input Capacitance	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V},$		394		pF
Coss	Output Capacitance	f = 1.0 MHz		53		pF
C _{rss}	Reverse Transfer Capacitance			23		pF
Switchir	ng Characteristics (Note 2)		1	1		1
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -30 V, I_D = -1 A,$		6	12	ns
t _r	Turn–On Rise Time	$V_{GS} = -10$ V, $R_{GEN} = 6 \Omega$		9	18	ns
t _{d(off)}	Turn–Off Delay Time	_		16	29	ns
t _f	Turn–Off Fall Time			3	6	ns
Q _g	Total Gate Charge	$V_{DS} = -30 \text{ V}, \qquad I_D = -2.3 \text{ A},$ $V_{GS} = -10 \text{ V}$		9	13	nC
Q _{gs}	Gate-Source Charge			1.4		nC
Q_{gd}	Gate–Drain Charge			1.7		nC

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source Diode Forward Current				-1.7	Α
V_{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_{S} = -1.7 A$ (Note 2)		-0.8	-1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V$, $I_F = -2.3A$, $dI_F/dt = 100A/\mu s$		25		nS

Notes:

1. R_{8JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.

b)



78°C/W when mounted on a 0.5in² pad of 2 oz copper

a)



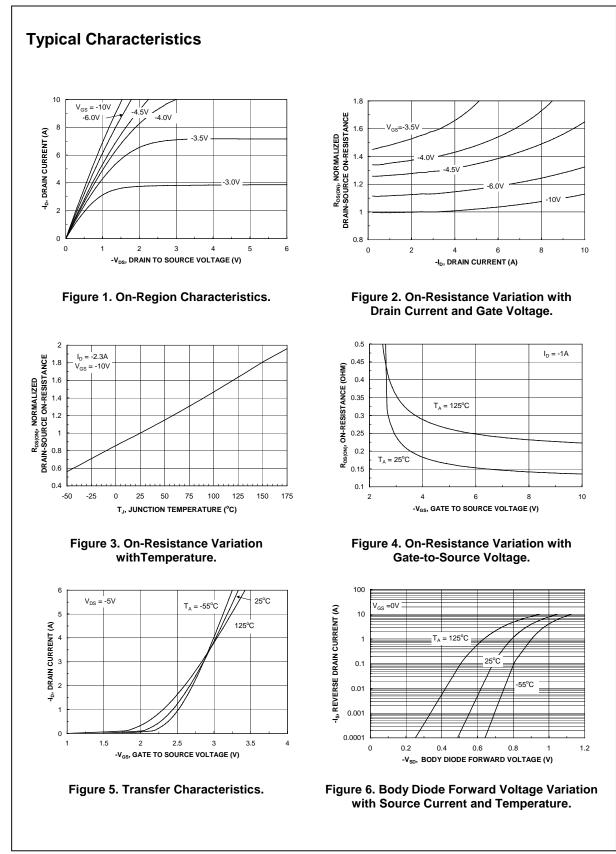
125°C/W when mounted on a 0.02 in² pad of 2 oz copper

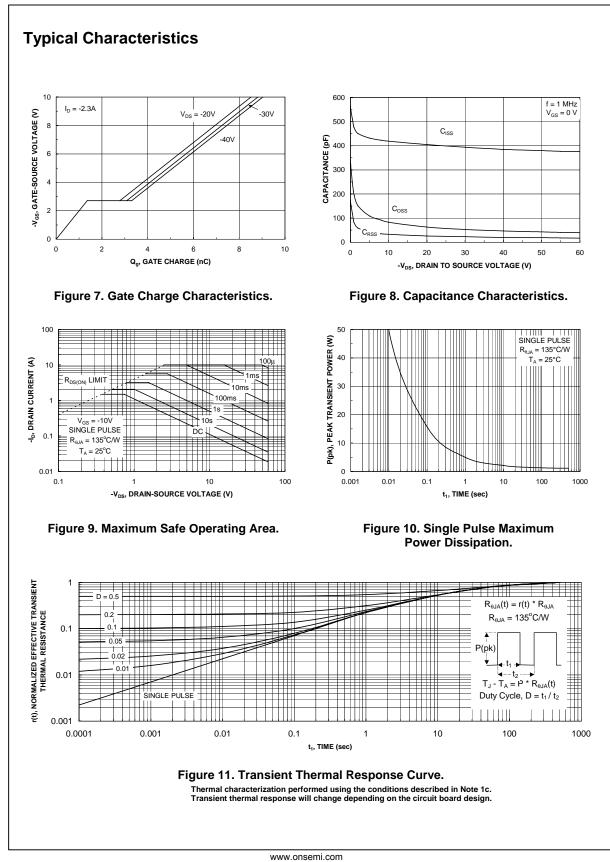
c) 135°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

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